



Flash Storage



8TB
Ample Storage



-40°C ~ 85°C
Wide Temperature



High IOPS
DRAM Buffer



A⁺
3K – 100K
P/E Cycle



Power Loss Protection
Hardware & Firmware

PCIe/NVMe



IU2P51GP **BICS8**

- Interface: PCIe Gen5x4
- Form Factor: U.2
- Capacity: 512GB – 16TB
- R/W Speed: 14,000/13,000MB/s



IM2P41B8(P) **BICS5**

- Interface: PCIe Gen4x4
- Form Factor: M.2 2280
- Capacity: 256GB – 8TB
- R/W Speed: 7,000/6,500MB/s

SATA



ISSS31AP **BICS5**

- Interface: SATA III
- Form Factor: 2.5"
- Capacity: 4TB – 8TB
- R/W Speed: 550/520MB/s



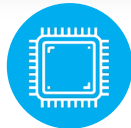
IHSS316 **BICS5**

- Interface: SATA III 6.0Gbps
- Form Factor: Half Slim (MO-297)
- Capacity: 128GB – 2TB
- R/W Speed: 560/520MB/s

DDR5 6400



6400 MT/s



PMIC & CKD



1.1V



64GB



On-Die ECC

R-DIMM



- Interface: DDR5 R-DIMM
- Frequency: 6400MT/s
- Capacity: 16GB – 64GB
- Voltage: 1.1V

CU-DIMM



- Interface: DDR5 CU-DIMM
- Frequency: 6400MT/s
- Capacity: 8GB – 64GB
- Voltage: 1.1V

CSO-DIMM



- Interface: DDR5 CSO-DIMM
- Frequency: 6400MT/s
- Capacity: 8GB – 64GB
- Voltage: 1.1V

Others



IUMU211 **MLC**

- Interface: USB 2.0
- Form Factor: USB 10 Pin
- Capacity: 8GB – 32GB
- R/W Speed: 43/32MB/s



IPC39 **MLC/SLC**

- Interface: PATA
- Form Factor: CF50 pin type I
- Capacity: 2GB – 128GB
- R/W Speed: 125/125MB/s



ICFS31C **BiCS5**

- Interface: SATA III
- Form Factor: CFast 2.0
- Capacity: 128GB – 1TB
- R/W Speed: 560/500 MB/s



IUDD33K **BiCS5**

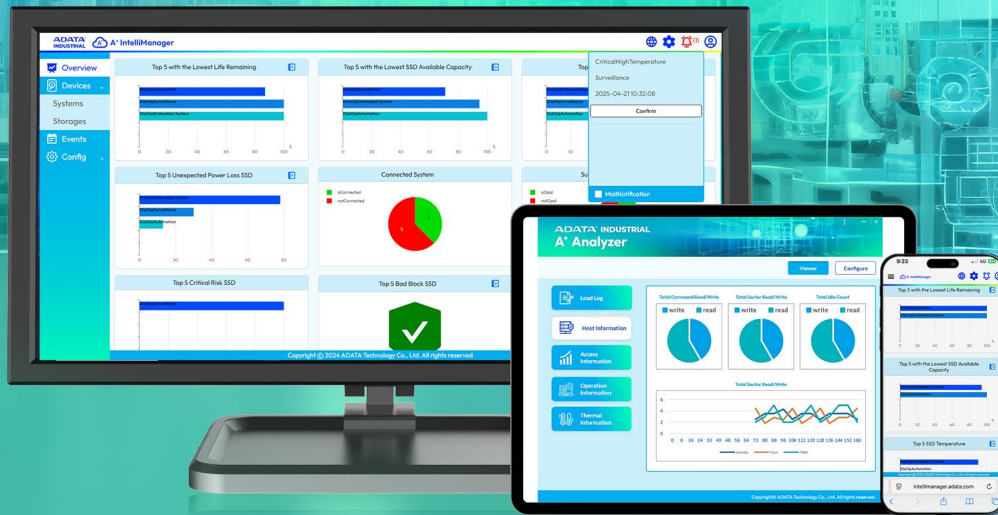
- Interface: SD 6.1
- Form Factor: micro SD
- Capacity: 16GB – 512GB
- R/W Speed: 97/80MB/s

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